

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LCX540F, TC74LCX540FK

Low-Voltage Octal Bus Buffer (inverted) with 5-V Tolerant Inputs and Outputs

The TC74LCX540 is a high-performance CMOS octal bus buffer. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

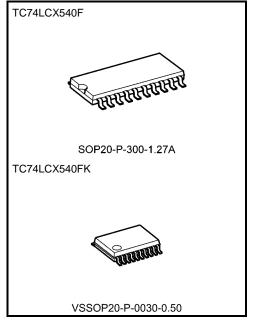
The device is designed for low-voltage (3.3 V) $V_{\rm CC}$ applications, but it could be used to interface to 5 V supply environment for both inputs and outputs.

The TC74LCX540 is an inverting 3-state buffer having two active-low output enables. When either $\overline{OE}1$ or $\overline{OE}2$ are high, the terminal outputs are in the high-impedance state. This device is designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge.

Features

- Low-voltage operation: VCC = 1.65 to 3.6 V
- High-speed operation: $t_{pd} = 6.5 \text{ ns (max) (V}_{CC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Output current: $|I_{OH}|/I_{OL} = 24 \text{ mA (min) (V}_{CC} = 3.0 \text{ V)}$
- Available in JEITA SOP, VSSOP (US)
- · Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 540 type



Weight:

SOP20-P-300-1.27A : 0.22 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)

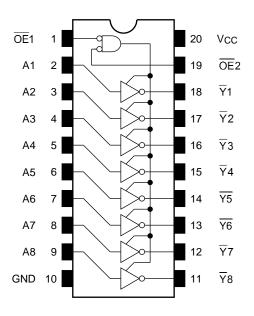
Note: The Electrical Characteristics of V_{CC} = 1.8 \pm 0.15 V is only applicable for products which manufactured from January 2009 onward.

Start of commercial production 1995-02

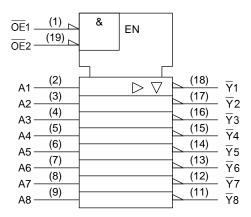
2021-03-26



Pin Assignment (top view)



IEC Logic Symbol



Truth Table

	Outputo		
OE1	OE2	An	Outputs
Н	Х	Х	Z
Х	Н	Х	Z
L	L	Н	L
L	L	L	Н

X: Don't care

Z: High impedance



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	Vcc	-0.5 to 7.0	V
DC input voltage	VIN	-0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	
DC output voltage	Vout	-0.5 to V _{CC} $+ 0.5$ (Note 3)	V
Input diode current	lıĸ	-50	mA
Output diode current	Іок	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	PD	180	mW
DC Vcc/ground current	ICC/IGND	±100	mA
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: Vout < GND, Vout > Vcc

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit	
Dower aupply voltage	Voc	1.65 to 3.6	V	
Power supply voltage	Vcc	1.5 to 3.6 (Note 2)	V	
Input voltage	VIN	0 to 5.5	V	
Output voltage	Vout	0 to 5.5 (Note 3)	V	
Output voltage	VOU1	0 to Vcc (Note 4)	V	
Output current	IOH/IOI	±24 (Note 5)	mA	
Output current	IOH/IOL	±12 (Note 6)	IIIA	
Operating temperature	T _{opr}	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

Note 2: Data retention only

Note 3: Output in OFF state

Note 4: High or low state

Note 5: VCC = 3.0 to 3.6 V

Note 6: VCC = 2.7 to 3.0 V

Note 7: VIN = 0.8 to 2.0 V, VCC = 3.0 V



Electrical Characteristics

DC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics Symbol Test Condition						Min	Mari	11-2		
Characteris	tics	Symbol	V V		Vcc (V)	Min	Max	Unit		
H-level					1.65 to 2.3	V _{CC} × 0.9	_			
		VIH	_	_		1.7	_			
lonut voltage					2.7 to 3.6	2.0	_	V		
Input voltage					1.65 to 2.3	_	V _{CC} × 0.1			
	L-level	VIL	_	-	2.3 to 2.7	_	0.7			
					2.7 to 3.6	_	0.8			
				I _{OH} = -100 μA	1.65 to 3.6	V _{CC} -0.2	_			
				IOH = -4 mA	1.65	1.05	_			
	l l laval	\/a	\(\(\)\(\)\(\)\(\)\(\)\(\)\(\)\(\)\(\)\	IOH = -8 mA	2.3	1.7	_	V		
	H-level	Voн	VIN = VIH or VIL	I _{OH} = -12 mA	2.7	2.2	_			
				IOH = -18 mA	3.0	2.4	_			
Outrout walks as				IOH = -24 mA	3.0	2.2	_			
Output voltage			VIN = VIH or VIL	I _{OL} = 100 μA	1.65 to 3.6	_	0.2			
				IOL = 4 mA	1.65	_	0.45			
	Linnel	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		I _{OL} = 8 mA	2.3	_	0.7			
	L-level	VoL		I _{OL} = 12 mA	2.7	_	0.4			
						IOL = 16 mA	3.0		0.4	
				I _{OL} = 24 mA	3.0	_	0.55			
Input leakage current		lıN	V _{IN} = 0 to 5.5 V	V _{IN} = 0 to 5.5 V		_	±5.0	μА		
3-state output off-state	-state output off-state current IOZ $V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 5.5 \text{ V}$		1.65 to 3.6	_	±5.0	μΑ				
Power off leakage cur	ower off leakage current IOFF		$V_{IN}/V_{OUT} = 5.5 V$		0	_	10.0	μΑ		
		loo	V _{IN} = V _{CC} or GND		1.65 to 3.6	_	10.0			
Quiescent supply curr	ent	Icc	VIN/VOUT = 3.6 to 5	5.5 V	1.65 to 3.6	_	±10.0	μΑ		
Increase in I _{CC} per in	put	Δlcc	V _{IH} = V _{CC} - 0.6 V ((per 1 input)	2.7 to 3.6	_	500			



AC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics	Symbol Test Condition			Min	Max	Unit
Characteristics	Symbol	rest Condition	V _{CC} (V)	IVIIII	IVIAX	Unit
			1.8 ± 0.15		25.0	
Propagation delay time	t _{pLH}	Figure 1, Figure 2	2.5 ± 0.2		8.5	nc
Propagation delay time	t _{pHL}	rigule 1, rigule 2	2.7	_	7.5	ns
			3.3 ± 0.3	1.5	6.5	
	^t pZL ^t pZH	Figure 1, Figure 3	1.8 ± 0.15	_	34.0	ns
Outside south time			2.5 ± 0.2	_	17.0	
Output enable time			2.7	_	9.5	
			3.3 ± 0.3	1.5	8.5	
	t _{pLZ}	Figure 1, Figure 3	1.8 ± 0.15		32.0	
Output disable time			2.5 ± 0.2	_	16.0	nc
Output disable time	t _{pHZ}		2.7	_	8.5	ns
			3.3 ± 0.3	1.5	7.5	
Output to output skow	tosLH	(Noto)	2.7	_	_	
Output to output skew	tosHL	(Note)	3.3 ± 0.3	_	1.0	ns

Note: Parameter guaranteed by design.

(tosLH = |tpLHm - tpLHn|, tosHL = |tpHLm - tpHLn|)

Dynamic Switching Characteristics (Ta = 25°C, input: tr = tf = 2.5 ns, CL = 50 pF, RL = 500 Ω)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic V _{OL}	VOLP	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	V
Quiet output minimum dynamic V _{OL}	Volv	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	V

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	CIN	_	3.3	7	pF
Output capacitance	Cout	_	3.3	8	pF
Power dissipation capacitance	C _{PD}	f _{IN} = 10 MHz (Note	3.3	40	pF

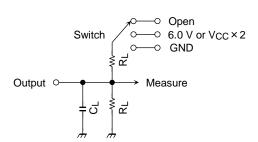
Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation:

ICC (opr) = $CPD \cdot VCC \cdot fIN + ICC/8$ (per bit)



AC Test Circuit



Parameter	Switch		
tpLH, tpHL	Open		
* · = * =	6.0 V	@ V _{CC} =3.3±0.3V @ V _{CC} =2.7V	
t _{pLZ} , t _{pZL}	V _{CC} ×2	@ V _{CC} =2.5±0.2V @ V _{CC} =1.8±0.15V	
t _{pHZ} , t _{pZH}	GND		

Figure 1

AC Waveform

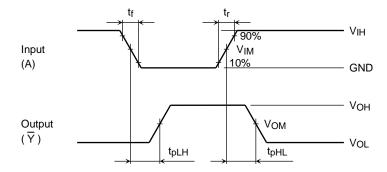


Figure 2 t_{pLH}, t_{pHL}



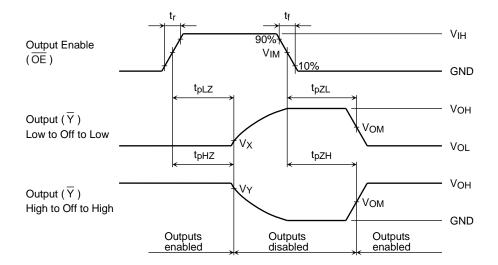


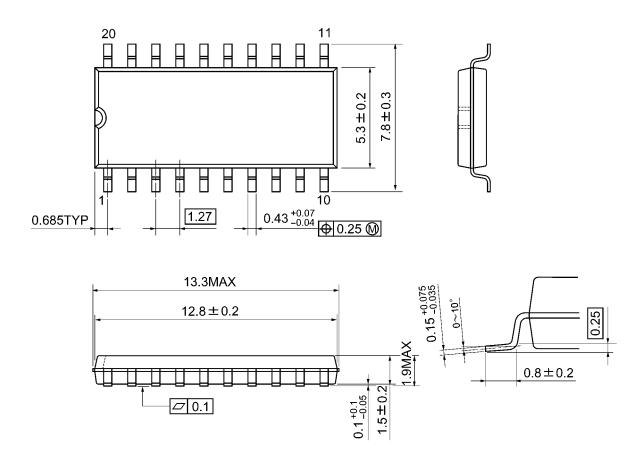
Figure 3 $t_{pLZ}, t_{pHZ}, t_{pZL}, t_{pZH}$

		Vcc					
	Symbol	$3.3 \pm 0.3 \text{ V}$ 2.7 V	2.5 ± 0.2 V	1.8 ± 0.15 V			
Input	VIH	2.7 V	Vcc	Vcc			
	VIM	1.5 V	Vcc/2	V _{CC} /2			
	t _r , t _f	2.5 ns	2.0 ns	2.0 ns			
Output	Voм	1.5 V	V _{OH} /2	V _{OH} /2			
	VX	V _{OL} +0.3 V	V _{OL} +0.15 V	V _{OL} +0.15 V			
	VY	V _{OH} -0.3 V	V _{OH} -0.15 V	V _{OH} -0.15 V			
Load	CL	50 pF	30 pF	30 pF			
	RL	500 Ω	500 Ω	1 kΩ			



Package Dimensions

SOP20-P-300-1.27A Unit: mm

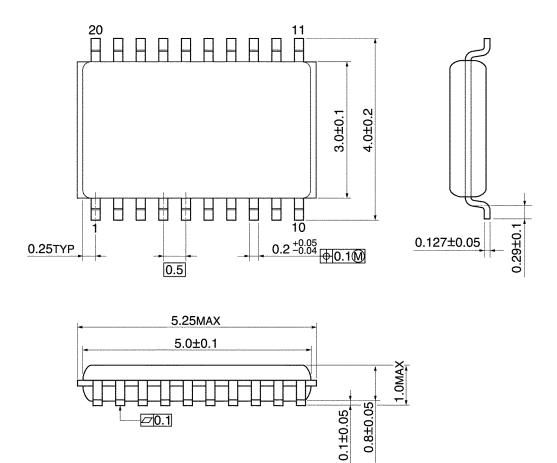


Weight: 0.22 g (typ.)



Package Dimensions

VSSOP20-P-0030-0.50 Unit: mm



Weight: 0.03 g (typ.)



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